said attachment opening, the attachment portion having a shank portion extending through the attachment opening and a flange portion at the end of said shank portion opposite the base portion for engagement with the outwardly facing surface and for retaining the attachment portion in the attachment opening thereby securing the wafer engagement component to the wall, the flange portion configured to allow insertion of the attachment portion into the attachment opening by deflecting laterally the flange portion, the wafer engagement component engaging the wall in at least three non-linearly positioned points for providing a stable foundation for the wafer engagement component on the wall.

13. A wafer enclosure comprising an enclosure portion and a door, the enclosure portion with a front having a door frame defining a front opening for insertion and removal of wafers, the enclosure portion having a plurality of horizontally oriented slots vertically stacked for receiving a plurality of axially aligned horizontally oriented wafers, the door configured for closing the open front and latching to the door frame, the door having an interiorly facing side and a first upright cushion base portion and a second upright cushion base portion attached to the door at said interiorly facing side, each of the upright cushion[s having an elongate] base portions [and] having a plurality of parallel wafer engaging fingers extending from said cushion base portion, each wafer engaging finger having a wafer engagement portion, [each wafer engaging fingers of engaging alternate ones of the axially aligned horizontally oriented wafers and wherein the wafers engaged by the first cushion are different that the wafers engaged by the second cushion] the engagement of each sequential wafer alternating between the plurality of wafer engagement portions of the first upright cushion base portion and the plurality of wafer engagement portions of the second upright cushion base portion, wherein the wafer engagement portions of the fingers of the first upright cushion base are laterally spaced from the engagement portions of the fingers of the second base portions.

14. A wafer enclosure comprising an enclosure portion and a door, the enclosure portion with a front having a door frame defining a front opening for insertion and removal of wafers, the enclosure portion having a plurality of horizontally oriented slots vertically stacked for receiving

a plurality of axially aligned horizontally oriented wafers, the door configured for closing the open front and latching to the door frame, the door having an interiorly facing side and a first upright cushion base portion and a second upright cushion base portion attached to the door at said interiorly facing side, each of the upright cushion base portions having a plurality of parallel wafer engaging fingers extending from said cushion base portion, each wafer engaging finger having a wafer engagement portion, each sequential wafer engagement portion of each wafer engaging finger of each respective cushion base portion engaging alternate ones of the axially aligned horizontally oriented wafers by the respective wafer engagement portions, wherein the wafers engaged by the first upright cushion base portion are different than the wafers engaged by the second upright cushion base portion, [The wafer enclosure of claim 13,] wherein each wafer engaging finger of each cushion extends laterally from the base in a first direction and wherein each wafer cushion base portion further comprises at least one integral extension member extending laterally from the base portion in the first direction, and wherein said extension member has an intermediate portion and a door contact portion opposite the base portion whereby when wafers engage said wafer engagement fingers the door contact portion bears against the door thereby precisely controlling the engagement of the wafer engagement fingers with the wafers.

A2 cmd.

16. (amended) A wafer enclosure comprising an enclosure portion and a door, the enclosure portion having a front with a door frame defining a front opening for insertion and removal of wafers, the enclosure portion configured for receiving a plurality of axially aligned horizontally oriented wafers, the door configured for closing the open front, the door having an interiorly facing side and a first upright cushion attached to the door, said first cushion having an elongate base portion attached to the door and a plurality of parallel wafer engaging fingers extending from said base portion in a first direction, each wafer engaging finger having a[n] finger portion and a wafer engaging portion, the wafer engaging portion laterally displaced in a first direction from the base portion, the cushion further having a door contacting member displaced laterally in the first direction from the base portion for providing support to the wafer engagement fingers.

A3

[rigid] comprised of plastic with an aperture extending therethrough and a wafer cushion configured for attachment to said enclosure at said aperture without the use of separate fasteners, the [component] cushion having a base portion confronting the wall portion with a plurality of prongs extending outwardly therefrom[, the prongs] for engaging with the wall portion at the aperture, [having an outer wafer engaging surface,] the cushion comprising PEEK.

A3 cancel.

Please add new claims 21- 25 as follows:

Sub B3 A4

21. A wafer enclosure for carrying wafers, the enclosure comprising a rigid outer shell with an open front and a door to close said open front, said door having a rigid wall portion comprised of plastic, and a wafer cushion for attachment to said door at said aperture without the use of separate fasteners, the component having a base portion confronting the wall portion with a plurality of wafer engagement fingers extending outwardly therefrom, the wafer engagement fingers each having an outer wafer engaging surface, the cushion comprising PEEK.

22. A wafer enclosure comprising an enclosure portion and a door, the enclosure portion with a front having a door frame defining a front opening for insertion and removal of wafers, the enclosure portion having a plurality of horizontally oriented slots vertically stacked for receiving a plurality of axially aligned and horizontally oriented wafers, the door configured for closing the open front and latching to the door frame, the door having an interiorly facing side, and a cushion attached at the interiorly facing side, the cushion comprising a first plurality of vertically aligned wafer engagement portions, and a second plurality of vertically aligned wafer engagement portions horizontally spaced from the first plurality, each sequential wafer being engaged by alternately wafer engagement portions of the first plurality and wafer engagement portions of the second plurality.

23. The wafer enclosure of claim 22 wherein the cushion comprises a first cushion base portion and a second cushion base portion, and wherein the first plurality of wafer engagement

A